















### Safe Harbor Statement

This presentation and discussion contain forward-looking statements, including our expectations for future revenues, expense reductions, profits, and other results that are forward-looking statements under the SEC's safe harbor provision. These forward-looking statements are based on management's current expectations, and are subject to the risks inherent in our business. These risks are described in detail in our Form 10-K annual report and other SEC filings. Our actual results may differ materially from our current expectations. We do not assume any obligation to update these forward-looking statements.



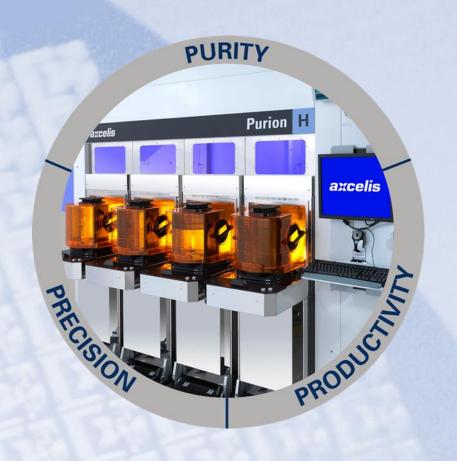
### Axcelis at a Glance

- Global leader in technology development and manufacturing of ion implant systems and services for the semiconductor industry for 40 years
  - Serving an estimated \$1B ion implant systems market
  - Based in Beverly, MA with headcount of approximately 1000 worldwide
  - Global infrastructure supporting customers in 31 countries
  - Growing installed base of over 3200 tools
  - Strong IP portfolio with >800 patents
- Supplier of record to leading semiconductor CAPEX spenders in all market segments including DRAM, Flash, Foundry and Logic





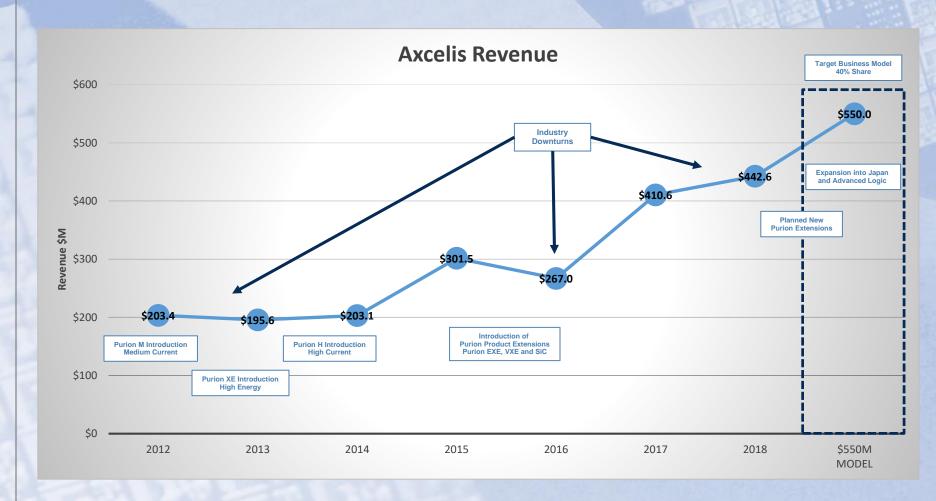
# The Purion Platform...Key to Market Share Leadership and Achieving our Target Financial Business Model



- Innovative scanned spot beam architectures with advanced energy filters
- Common endstation and control system
- Advanced source technology



# Axcelis Revenue Growth in the Purion Era





# Target Business Model (GAAP) The Path to Market Share Leadership

Revenue	\$301.5M 2015(A)	<b>\$267M</b> 2016(A)	\$410.6M 2017(A)	\$442.6 <b>M</b> 2018(A)	\$550M Model*
Gross Margin	33.7%	37.3%	36.6%	40.6%	42-43%
Total OPEX	26.8%	31.1%	24.9%	27.0%	~25%
Operating Profit	6.9%	6.2%	11.7%	13.5%	17-18%
Free Cash Flow (Cash From Operations – Capex)	5.5%	(4.1%)	11.9%	9.5%	>15%



<sup>\*</sup> The \$550M revenue model is not a forecast of results for any identified period, but is intended to be indicative of the annual results Axcelis may achieve based on our strategic objectives.

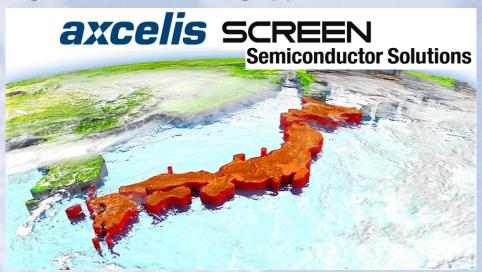
# 2019 Objectives – Build on the strength of the Purion Platform

- 1. Grow our Purion footprint within our existing customer base
- 2. Penetrate Japanese and advanced foundry/logic market with Purion
  - Represents approximately \$300M of the \$1B ion implant TAM
- 3. Capitalize on successful market segmentation strategy by releasing new Purion product extensions focused on key market segments
  - Power device Silicon Carbide and Silicon
  - CMOS Image Sensor Deep red and infrared
  - Purion H for Advanced Logic with advanced capabilities
  - Purion H for Mature Process Technology focused on Productivity



# Reentering the Japanese Market Elements of Axcelis and SCREEN SPE\* Collaboration

- SCREEN SPE to distribute and service advanced Purion ion implantation technology in Japan
  - Japanese market represents 15% of the overall \$1B ion implant TAM
- Companies to establish training and demonstration facility at SCREEN SPE Process Technology Center in Hikone, Japan
- Agreement includes joint technical collaboration for emerging implant, thermal processing and wafer cleaning applications





# Why Customers Choose Purion

# Focused Segment Differentiation

# Advanced Technology

- Spot Beam Architecture
- Precise angle, dose and energy control for superior uniformity
- ELS4 Ion Source
- Significant cost of ownership benefit
- Common Purion Platform
  - Facilitates customer adoption of additional Purion products

- Advanced Memory/Logic
   Scanned spot beam
  - Image Sensors
     Higher energies
    - Power Devices
      - 150mm SiC hot implant
        - Internet of Things
        - 200mm/300mm commonality

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#### **Customer Innovation Benefit**

- Competition provides customers with major yield and throughput advantages
- Customer's maximum innovation benefit is achieved by evenly splitting the implant business



# **Axcelis Purion Platform** Most Innovative Ion Implant Products Available

Three Unique and Enabling Beamlines + Common Endstation

**Enhanced Scanned Spot Beam Technology** 





- **500WPH End Station**
- Vector Control System<sup>™</sup>
- Eterna ELS4 Source™





**RF Linear Accelerator Technology** 



**Energy Filter Based** 



High Energy

















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# Purion Driving Customer Innovation Through Product Extensions and New Applications Capabilities

**Product Line Extensions Product Line New Applications Purion H2 Material Modification Thermal Implant Control** For Memory & **ProductivityScan Advanced Logic High Current Advanced Source, ELS4** ~60% of TAM XE **EXE Image Sensor 3D NAND VXE High Energy** ~20% of TAM **Silicon Carbide Power** 150mm **Devices Hot Implant** Medium Current ~20% of TAM **Purion Platform Market Share Growth** 



# Purion Power Series Optimized for the Growing Power Device Market

Purion		SiC			Si		
Power Series		M	XE	Н	M	XE	Н
	Aluminum Implantation	<b>✓</b>	<b>✓</b>		<b>✓</b>	✓	
	150mm Wafer Handling	<b>✓</b>	<b>✓</b>		<b>✓</b>	✓	
	Hot Implantation to 700°C For 150mm Wafers	<b>✓</b>	<b>✓</b>		<b>✓</b>	<b>✓</b>	
	80keV Antimony Implantation				✓		✓
	200mm Thin Wafer Handling				<b>✓</b>		✓
	80keV High Current Capability						✓

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### Axcelis Share Repurchase Program

- Board of Directors has authorized a share repurchase program of up to \$35 million of the company's common stock
- Reflects continued confidence in Axcelis' financial performance and long term outlook
- Strong balance sheet and cash flows enable:
  - Return cash to shareholders through share repurchases
  - Investments in internal and external opportunities to strengthen our product lines and drive long-term growth
- Repurchased \$14M of stock in Q2 2019



# Q2 2019 Financial Results

	Q2 2019 (GAAP)
Revenue	\$74.3M
Gross Margin	42.7%
Combined R&D and SG&A Expenses	\$29.7M
Operating Profit	\$2.0M
Net Income	\$0.6M
EPS	\$0.02
Total Cash	\$143.2M
Debt	\$0
Inventory	\$135.1M

### **Q3 2019 Financial Outlook**

As Guided (GAAP)

**Revenue** \$65 – 75M

Gross Margin ~41%

Combined R&D and SG&A Expenses ~\$29.7M

Operating Profit (\$1.2) – \$2.0M

EPS (\$0.05) - \$0.05

# Aggressive Gross Margin Improvement Activities

- Accelerated value engineering and supply chain cost out projects across the Purion product family
- Aggressively pursuing volume purchase agreements in low cost regions
- Manufacturing hours decreasing due to multiple lean initiatives
- Expect lower warranty and install costs from local installation teams as learning is applied to new shipments to previously penetrated Fabs
- Warranty costs are being positively impacted by follow on order volume, Purion Platform maturity and parts quality improvements

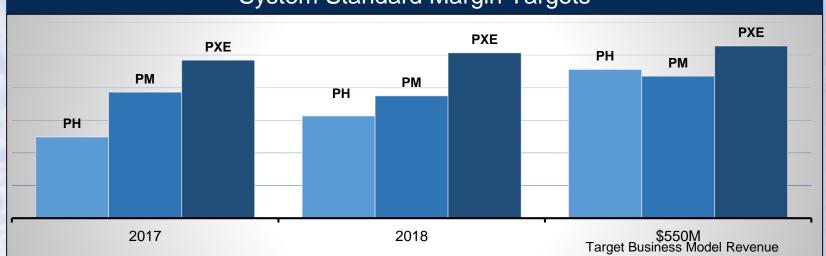


# Gross Margins Driven by Product Maturity, Volume and Cost Out Initiatives





#### **System Standard Margin Targets**



### The Impact of Mix and Initiatives on Gross Margin

 Gross Margin Improvement Driven by Improving Systems Margins on the Common Purion Platform

- Supply Chain Optimization
- Volume
- Warranty and Install
- Cost out Engineering
- Manufacturing Efficiency
- Product Extensions





### Managing Through the Downturn

- Investing in the business for growth in the coming upturn
  - Marketing building strong product roadmaps for key growth segments
  - R&D developing Purion product extensions for these market segments
  - Sales expanding Purion footprint in both existing and new customers
  - Companywide driving excellent customer satisfaction and quality
- Managing the business for profitability
  - Expected revenues down 20-25% compared to 2018
  - Full year operating expenses reduced by \$12M compared to budget through multiple actions
    - Temporary work force reduction and voluntary executive pay cut
    - Reduction in variable compensation expense
    - General belt tightening of expenses across the business
    - Non-critical infrastructure programs pushed to 2020
- Continued focus on gross margin improvement programs
  - Full year gross margins expected between 41.0% to 41.5%, up from 40.0% to 41.0%

**Investment Thesis** 

# Strong Long Term Industry Cycle Driven by – "Data-Centric Connected World"

#### **Application**

#### **Market Segment**

#### **Process Technology**

#### **DATA COLLECTION**

Sensors, microcontrollers, embedded memory, communications, 5G, analog, power devices etc..

#### **DATA STORAGE**

SSD, mobile, enterprise, datacenter, PC, 5G

#### **DATA ANALYTICS**

Microprocessors, applications processors, graphics processors, 5G



Memory

Advanced Logic

# MATURE PROCESS TECHNOLOGY

greater than 28nm logic, RF, Analog, Power

#### **MEMORY**

3D NAND, DRAM, PCRAM, ReRAM, MRAM

ADVANCED LOGIC FinFET, FDSOI



### **Axcelis Growth Opportunity**

- **Driven by market dynamics** 
  - Long term data centric growth cycle is still intact with growth driven by IoT, data storage and analytics
  - Maturing mobile market and capacity absorption in memory causing current slowdown
- **Driven by Purion market penetration** 
  - Mature process technology
  - Memory
  - Japan
  - **Advanced logic**
- Driven by investment in the development of new Purion product extensions and enhancements
  - Provide opportunities for implant growth beyond the \$550M model



# Evaluating Growth Beyond the Purion Platform

- **Assessing potential options** 
  - **Organic product development** 
    - New doping-based products focused on emerging technology requirements
  - **Inorganic growth** 
    - Technology acquisition followed by internal product development
    - **New product acquisition**
    - **Business unit M&A**

